PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2648294

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

	Name	Execution Date
CHUN-YI CHEN		12/10/2013

RECEIVING PARTY DATA

Name:	LITE-ON ELECTRONICS (GUANGZHOU) LIMITED	
Street Address	NO. 25, GUANGPU W. RD. GUANGZHOU SCIENCE CITY, GUANGZHOU HI-TECH INDUSTRIAL DEVELOPMENT ZONE	
City:	GUANGZHOU	
State/Country:	CHINA	

Name:	LITE-ON TECHNOLOGY CORPORATION	
Street Address: 22F., NO. 392, RUEY KUANG ROAD, NEIHU DIST.		
City:	TAIPEI CITY	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14106005

CORRESPONDENCE DATA

 Fax Number:
 (703)574-5876

 Phone:
 703-268-5992

 Email:
 zhuoxu83@gmail.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: LI&CAI INTELLECTUAL PROPERTY(USA) OFFICE

Address Line 1: 2820 SHAWN LEIGH DR
Address Line 4: VIENNA, VIRGINIA 22181

ATTORNEY DOCKET NUMBER:	102P001077US
NAME OF SUBMITTER:	ZHUO XU
	PAIENI

502601961 REEL: 031781 FRAME: 0047

14106005

00 0V3 | II

Signature:	/ZHUO XU/
Date:	12/13/2013
Total Attachments: 2 source=31077Assignment#page1.tif source=31077Assignment#page2.tif	

PATENT REEL: 031781 FRAME: 0048

LI&CAI INTELLECTUAL PROPERTY (USA) OFFICE 2820 SHAWN LEIGH DR, VIENNA, VA 22181

Telephone: (703) 268-5992 • Facsimile: (703) 575876 • Email: zxu@li-cai.com.tw

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application	n N	Jo. Filed
Insert Name(s) of Inventor(s)	⇔	***(Given Name FAMILY NAME (ALL CAPS))*** WHEREAS, CHUN-YI CHEN (FAMILY NAME: CHEN)
		(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:
Insert Title of Invention	⇨	WIRESSLESS TRANSMISSION DEVICE AND CONNECTING DEVICE
		for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application)
Insert Date of Signing of Appln.	⇔	On; and
Insert Name ot Assignee	⇨	WHEREAS, (1) LITE-ON ELECTRONICS (GUANGZHOU) LIMITED
		(2) LITE-ON TECHNOLOGY CORPORATION
Insert Address of Assignee	⇔	of (1) NO. 25, GUANGPU W. RD., GUANGZHOU SCIENCE CITY, GUANGZHOU HI-TECH INDUSTRIAL DEVELOPMENT ZONE, GUANGZHOU, P.R.C.
		(2) 22F., NO. 392, RUEY KUANG ROAD, NEIHU DIST., TAIPEI CITY, TAIWAN, R.O.C.
		its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and
Check Box if Appropriate	⇔	in any foreign countries.
		NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.
		The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

LI&CALINTELLECTUAL PROPERTY (USA) OFFICE

Page 1 of 2

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of LI&CAI INTELLECTUAL PROPERTY (USA) OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>DEC.10,2013</u>		CHUN-YI CHEN (FAMILY NAME: CHEN)
Date	Name of Inventor	Signature) CHVN-YI CHEN
Date	Name of Inventor	Signature)
Date	Name of Inventor	Signature)
Date	Name of Inventor	Signature)
Date	Name of Inventor	Signature)

LI&CAI INTELLECTUAL PROPERTY (USA) OFFICE

Page 2 of 2